



100V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D T _A = +25℃	
100\/	350mΩ @ V _{GS} = -10V	-2.4A	
-100V	450mΩ @ V _{GS} = -6V	-2.1A	

Description and Applications

This MOSFET is designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- DC-DC Converters
- Power Management Functions
- · Relay and Solenoid Driving

Features and Benefits

- Fast Switching Speed
- Low Input Capacitance
- Low Gate Drive
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

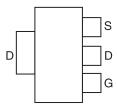
Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.112 grams (Approximate)

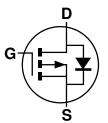
SOT223



Top View



Pin Out - Top



Equivalent Circuit

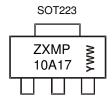
Ordering Information (Note 4)

Product	Case	Packaging
ZXMP10A17GTA	SOT223	1,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ZXMP 10A17 = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or $\overline{W}W$ = Week Code (01~53)



Maximum Ratings (@ $T_A = +25 \ ^{\circ}\!C$ unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	-100	V	
Gate-Source Voltage		V_{GS}	±20	V	
		(Note 6)		-2.4	
Continuous Drain Current	$V_{GS} = 10V$	T _A = +70 °C (Note 6)	I_{D}	-1.9	Α
		(Note 5)		-1.7	
Pulsed Drain Current	V _{GS} = 10V	(Note 7)	I _{DM}	-9.4	Α
Continuous Source Current (Body Diode) (Note 6)		I _S	-4.5	Α	
Pulsed Source Current (Body Diode) (Note 7)		I _{SM}	-9.4	А	

Thermal Characteristics (@T_A = +25 ℃ unless otherwise specified.)

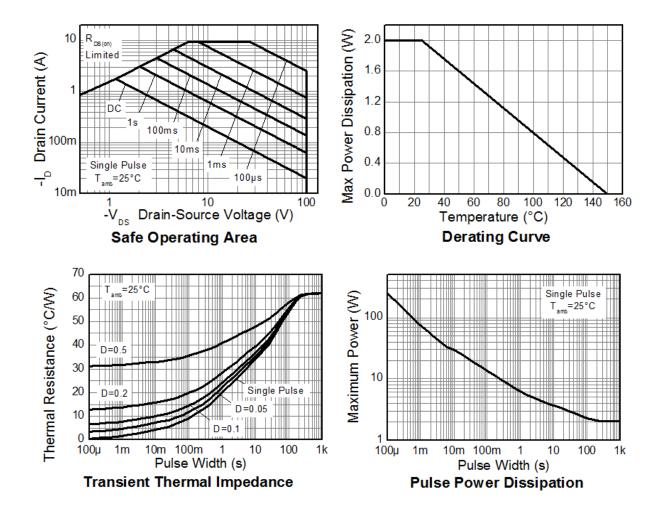
Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 5)	D.	2.0 16	mW/℃	
Linear Derating Factor	(Note 6)	P _D	3.9 31		
The second Descriptions of London to Applicate	(Note 5)	Б	62.5	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	32.0		
Thermal Resistance, Junction to Case	(Note 8)	$R_{ hetaJL}$	9.8		
Operating and storage temperature range		T _J , T _{STG}	-55 to 150	.€	

Notes:

- 5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 6. Same as Note 5, except the device is measured at $t \le 10$ seconds.
- Same as Note 5, except the device is pulsed with D= 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.
 Thermal resistance from junction to solder-point (at the end of the drain lead).



Thermal Characteristics





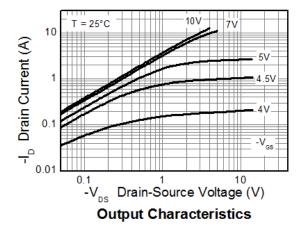
Electrical Characteristics (@TA = +25 ℃ unless otherwise specified.)

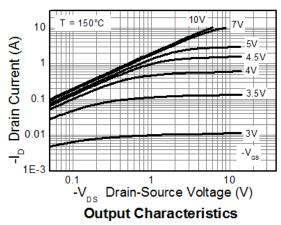
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	-100	_	_	V	$I_D = -250 \mu A, V_{GS} = 0V$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-0.5	μΑ	V _{DS} = -100V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(th)}$	-2.0		-4.0	٧	$I_{D}\text{= -250}\mu\text{A, }V_{DS}\text{= }V_{GS}$	
Static Drain-Source On-Resistance (Note 9)	D			0.350	Ω	V _{GS} = -10V, I _D = -1.4A	
Static Dialif-Source Off-nesistatice (Note 9)	R _{DS (ON)}			0.450	22	V _{GS} = -6V, I _D = -1.2A	
Forward Transconductance (Notes 9 & 10)	g fs		2.8		S	V _{DS} = -15V, I _D = -1.4A	
Diode Forward Voltage (Note 9)	V_{SD}	_	-0.85	-0.95	V	I _S = -1.7A, V _{GS} = 0V	
Reverse Recovery Time (Note 10)	t _{rr}		33		ns	I _F = -1.5A, di/dt= 100A/μs	
Reverse Recovery Charge (Note 10)	Q_{rr}		48	_	nC		
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{iss}	_	424	_	pF		
Output Capacitance	Coss	_	36.6	_	pF	V _{DS} = -50V, V _{GS} = 0V f= 1MHz	
Reverse Transfer Capacitance	C _{rss}	_	29.8	_	pF		
Total Gate Charge (Note 11)	Q_g	_	7.1	_	nC	V _{GS} = -6.0V	
Total Gate Charge (Note 11)	Q_g	_	10.7	_	nC	V _{DS} = -50V I _D = -1.4A	
Gate-Source Charge (Note 11)	Q _{gs}	_	1.7	_	nC		
Gate-Drain Charge (Note 11)	Q_{gd}	_	3.8	_	nC		
Turn-On Delay Time (Note 11)	t _{D(on)}	_	3.0	_	ns	V_{DD} = -15V, V_{GS} = -10V I_{D} = -1A, R_{G} \cong 6.0 Ω	
Turn-On Rise Time (Note 11)	t _r	_	3.5	_	ns		
Turn-Off Delay Time (Note 11)	t _{D(off)}	_	13.4	_	ns		
Turn-Off Fall Time (Note 11)	t _f		7.2		ns		

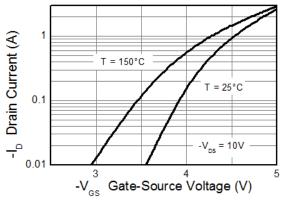
- 9. Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%.
 10. For design aid only, not subject to production testing.
 11. Switching characteristics are independent of operating junction temperatures.

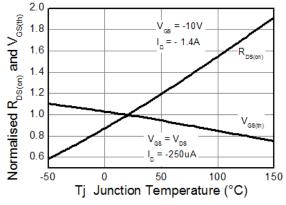


Typical Characteristics



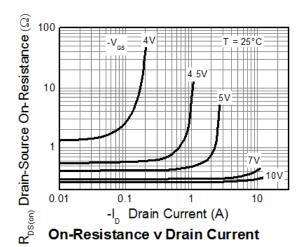


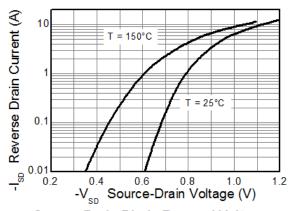




Typical Transfer Characteristics

Normalised Curves v Temperature

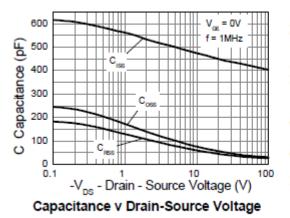


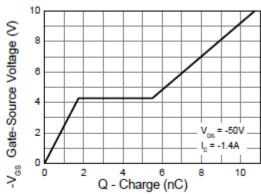


Source-Drain Diode Forward Voltage



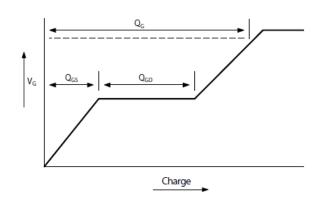
Typical Characteristics (cont.)



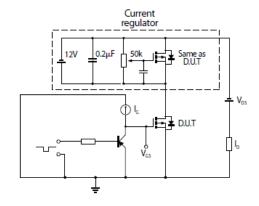


Gate-Source Voltage v Gate Charge

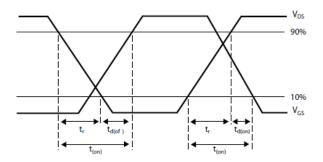
Test Circuits



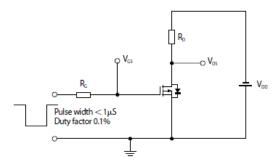
Basic gate charge waveform



Gate charge test circuit



Switching time waveforms

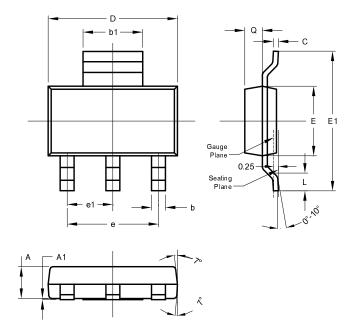


Switching time test circuit



Package Outline Dimensions

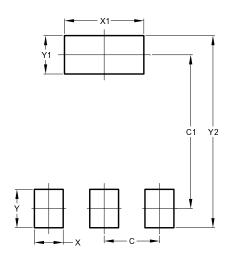
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223				
Dim	Min	Max	Тур	
Α	1.55	1.65	1.60	
A1	0.010	0.15	0.05	
b	0.60	0.80	0.70	
b1	2.90	3.10	3.00	
С	0.20	0.30	0.25	
D	6.45	6.55	6.50	
E	3.45	3.55	3.50	
E1	6.90	7.10	7.00	
е	-	-	4.60	
e1	-	-	2.30	
L	0.85	1.05	0.95	
Q	0.84	0.94	0.89	
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Υ	1.60
Y1	1.60
Y2	8.00



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